



# A Calorimeter for the LHCb upgrade II

Discussion – Tuesday 26<sup>th</sup> January 2021

Frédéric Machefert (IJCLab, Orsay)

Presentation based on the talks of

Renaud Legac (Marseille), Andreas Schopper (CERN), Stéphane T'Jampens (LAPP), David Gascon (Barcelona),  
Christophe Beigbeder (IJCLab), Max Chefdeville (LAPP)

given during the calo upgrade workshop (IN2P3), Dec. 17th 2020 & the upgrade meeting, Jan 21th, 2021

# Schedule : what are we talking about ?



	Date	Runs	Instantané $\mathcal{L}$ [ $\text{cm}^{-2} \text{s}^{-1}$ ]	Intégré $\mathcal{L}$ [ $\text{fb}^{-1}$ ]	Status
LHCb	2010 – 2018	Run 1 & 2	$4 \times 10^{32}$	9	terminé
LHCb Upgrade 1	2022 – 2030	Run 3 & 4	$2 \times 10^{33}$	50	approuvé
LHCb Upgrade 2	2032 –	Run 5 & au delà	$1.5 \times 10^{34}$	300	

Could imagine the installation of preliminary systems during the LS3(?)

# Situation

## **At present some documents have been published :**

- Expression of Interest for the upgrade II [CERN-LHCC-2017-003]
- Physics case for an LHCb Upgrade II [CERN-LHCC-2018-027]
- LHCb upgrades and operation at  $10^{34} \text{cm}^{-2} \cdot \text{s}^{-1}$  Luminosity – a first study [CERN-ACC-NOTE-2018-0038]

## **In Sept 2019, the LHCC request a Framework TDR from the collaboration**

- First technological choices, and gu-estimate of the performances reached
- Cost, Schedule and national contributions
- To be published in Sept 2021
  - Work has starting
  - The document has to be finalized during the summer

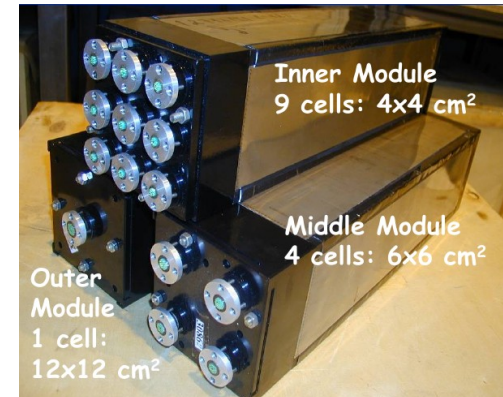
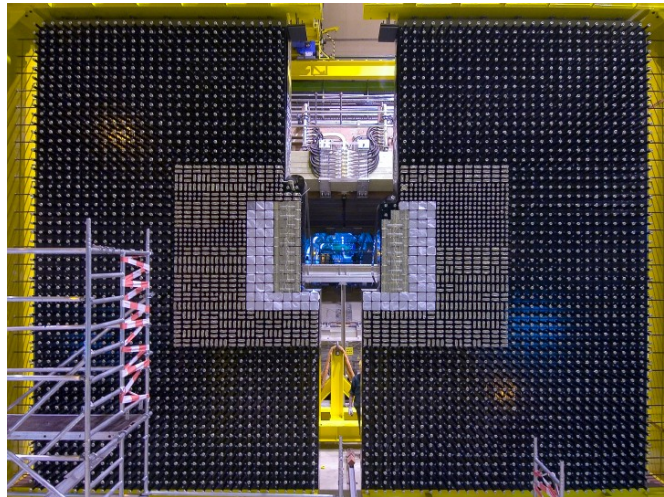
## **And what happened in France ?**

- A document was submitted to IN2P3 - Several projects : Tracking, Calo, Acquisition/Trigger
  - Calo concerns essentially IJCLab, LPC, LAPP... but other contributions would be welcome !

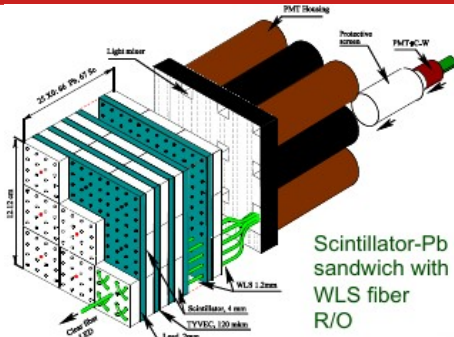
# Present ECAL



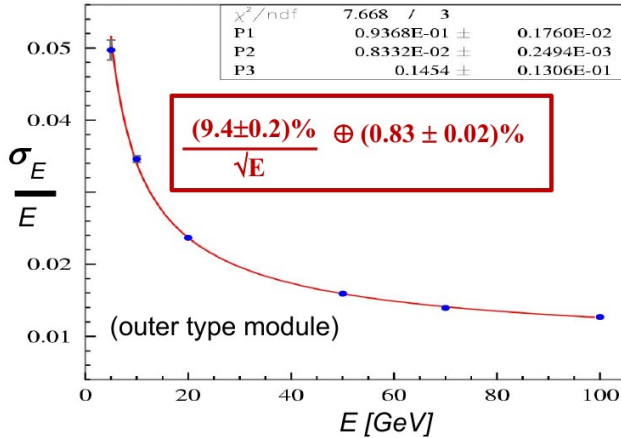
The LHCb ECAL is made 3312 modules, or 6016 channels  
It is adapted to luminosities up to a couple of  $10^{32}\text{cm}^{-2}\cdot\text{s}^{-1}$  and to doses up to 40kGy  
It contains 3 regions :  $4\times 4\text{cm}^2$ ,  $6\times 6\text{cm}^2$  and  $12\times 12\text{cm}^2$



# What is the aim ?



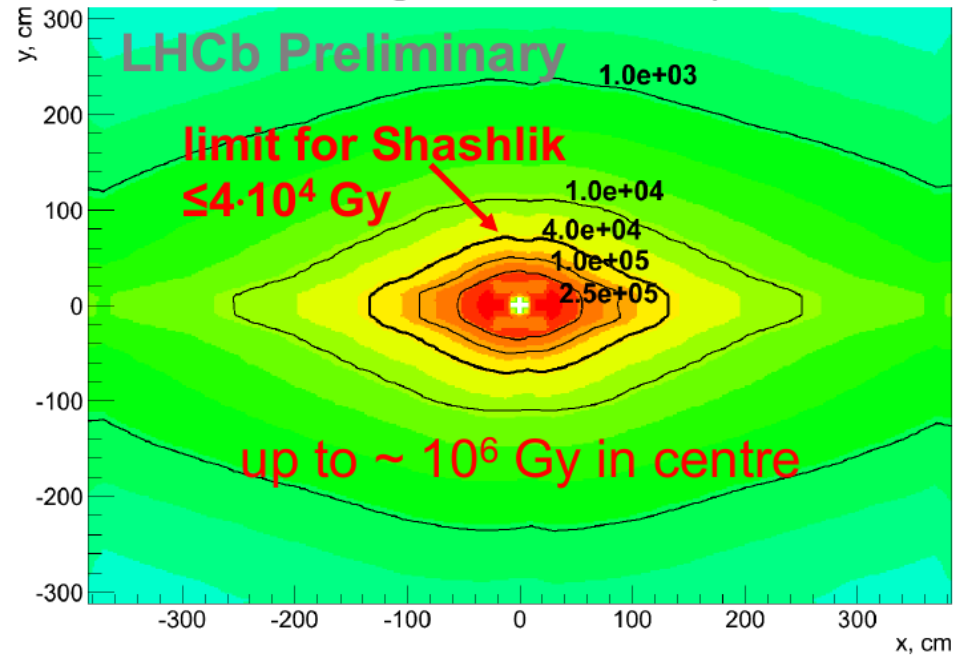
## Energy resolution with electrons



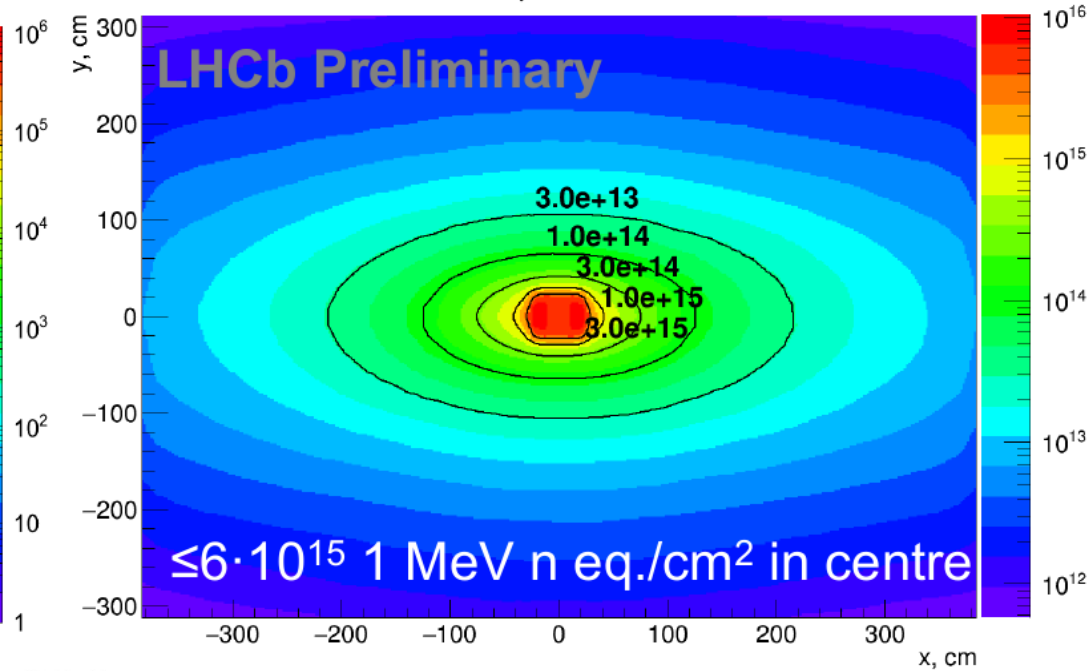
- Sustain a dose of up to 1MGy and  $6.10^{15}$  1MeV neq/cm<sup>2</sup>, 300fb<sup>-1</sup>
- Concerning the occupancies
  - Increase the granularity, especially close to the beam pipe where the occupancy is the largest
    - We have in parallel to reduce the Moliere radius (density of the absorber)
  - Get a time measurement O(10ps) to reduce the combinatorics
  - Potentially include a longitudinal segmentation
    - Shower separation, improve timing capabilities
- The performances should not be (too much) affected
  - Keep a good energy resolution (10%/√E)
  - Keep the modularity of the present detector (12x12cm<sup>2</sup> modules)

# Radiation problem

ECAL doses @ EM shower max, Gy, 300 /fb

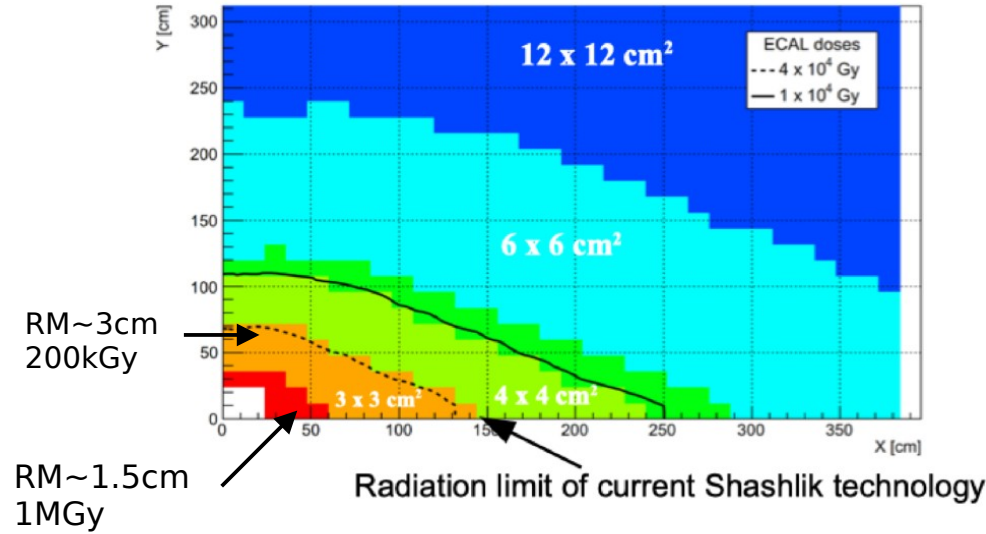


ECAL 1MeV neq/cm2, Z=1260, 300 /fb



Matthias Karacson  
& Yuri Guz

# Proposal for a new Calorimeter - Upgrade II



Cell size:

Modules:

SPACAL: GAGG & W

$1.5 \times 1.5 \text{ cm}^2$

32 new modules for extreme conditions of up to 1 MGy

SPACAL: Polystyrene & Pb

$3 \times 3 \text{ cm}^2$

144 new modules with “moderate” radiation requirements of up to  $\approx 200$  kGy

SPACAL + Shashlik

$4 \times 4 \text{ cm}^2$

272 new modules + 176 refurbished existing modules (add long. segmentation?)

Shashlik

$6 \times 6 \text{ cm}^2$

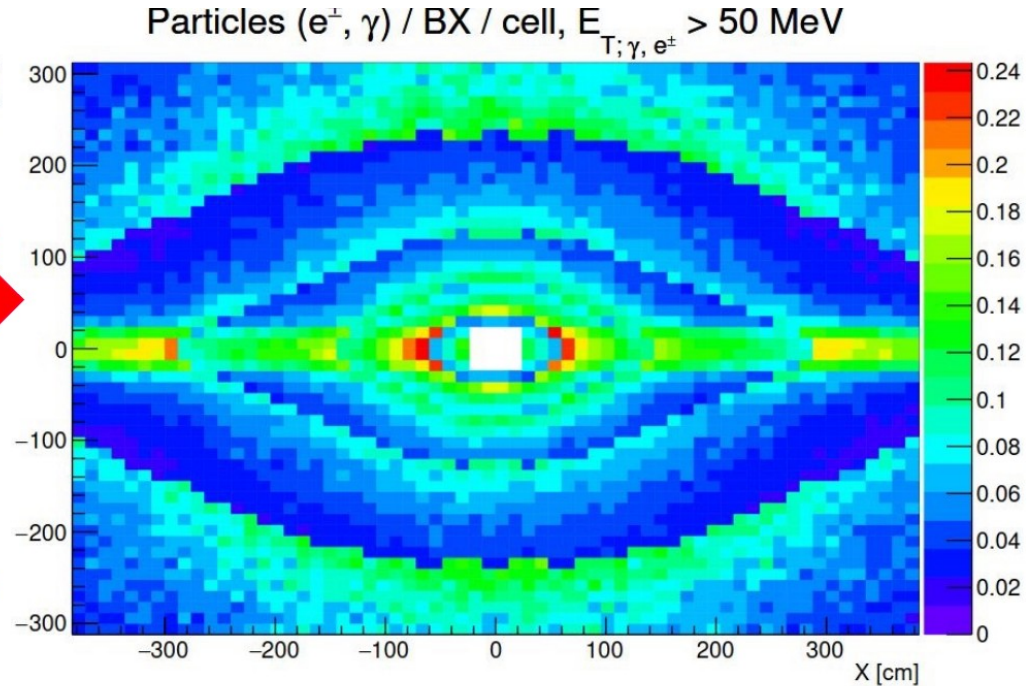
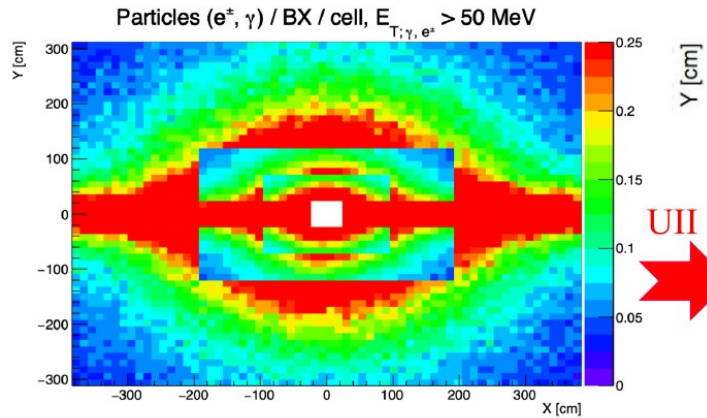
896 rebuilt + 448 refurbished existing modules (add long. segmentation?)

Shashlik

$12 \times 12 \text{ cm}^2$

1344 refurbished existing modules (add long. segmentation?)

# What would we obtain in term of occupancy ?



Mitigate high occupancies by:

- ✓ small cell size
- ✓ longitudinal segmentation (dual R/O)
- ✓ order 25-50 ps timing resolution
- ✓ optimized reconstruction algorithm

$$L = 1.5 \times 10^{34} \text{cm}^{-2} \cdot \text{s}^{-1}$$



# Foreseen technologies

## Ongoing technological investigation

### 1.5 x 1.5 cm<sup>2</sup> cell size region (32 modules):

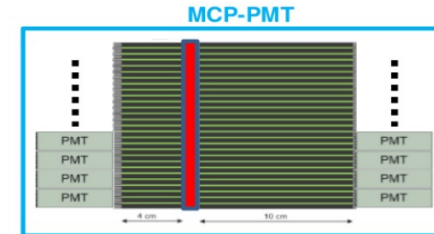
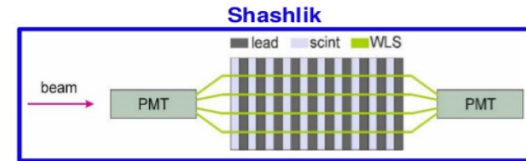
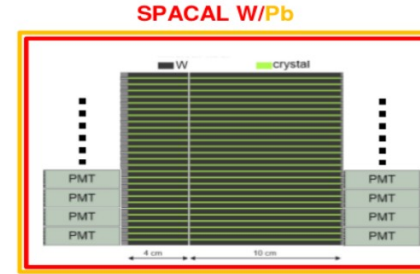
- **SPACAL W** with tungsten absorber (small Molière radius) and inorganic scintillator (radiation hard GAGG)  
Goal  $\approx 20 - 50$  ps -> *tested!*

### 3x3 cm<sup>2</sup> cell size region (144 modules):

- **SPACAL Pb** with lead absorber / polystyrene scintillating fibers (currently most promising option, preparing absorber)  
Goal  $\approx 20 - 50$  ps -> *tested with W absorber!*
- **Shashlik** (depending on radiation-hard wavelength shifting fibers)  
Goal  $\approx 20 - 50$  ps and reduced spill over-> *tested!*

### Timing layer:

- **MCP-PMT** (LAPPD) in the shower max, for improved Timing.  
Goal  $\approx 15 - 20$  ps precision -> *tested!*
- Alternative approach: Multi-layer Si-W ECAL  
→ investigated in simulation



« Spaghetti » calo and Shashlik have an already good intrinsic time resolution  
Addition of an extra timing layer to reach  $\sim 20$ ps

# Possible developments

## **The French groups are mostly interested by**

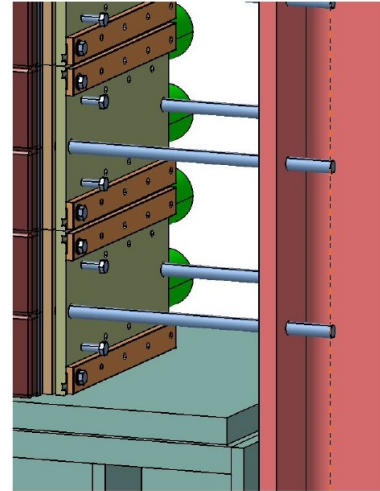
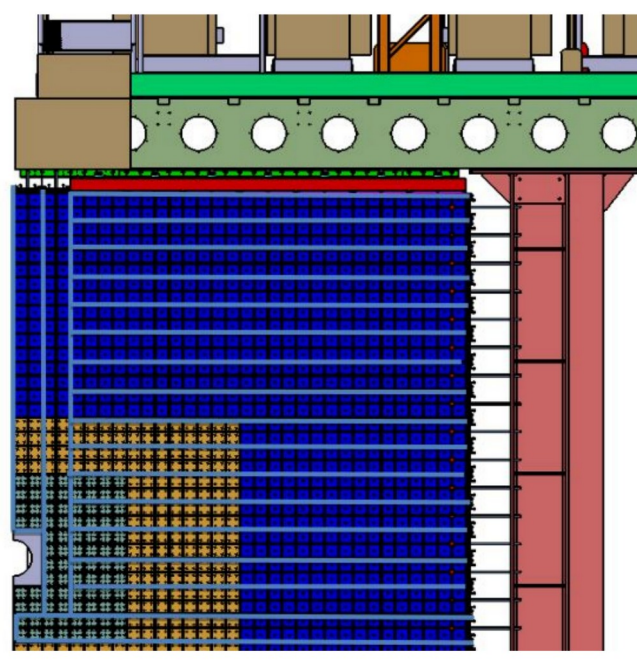
- Mechanics developments
- Detector design (sensitive and active medium)
- Electronics developments

In the past we have been mostly involved in Mechanics and Electronics

# Mechanics

Modules are grouped in double rows with are maintained by stainless-steel tape and tightened to the side structure of the ECAL

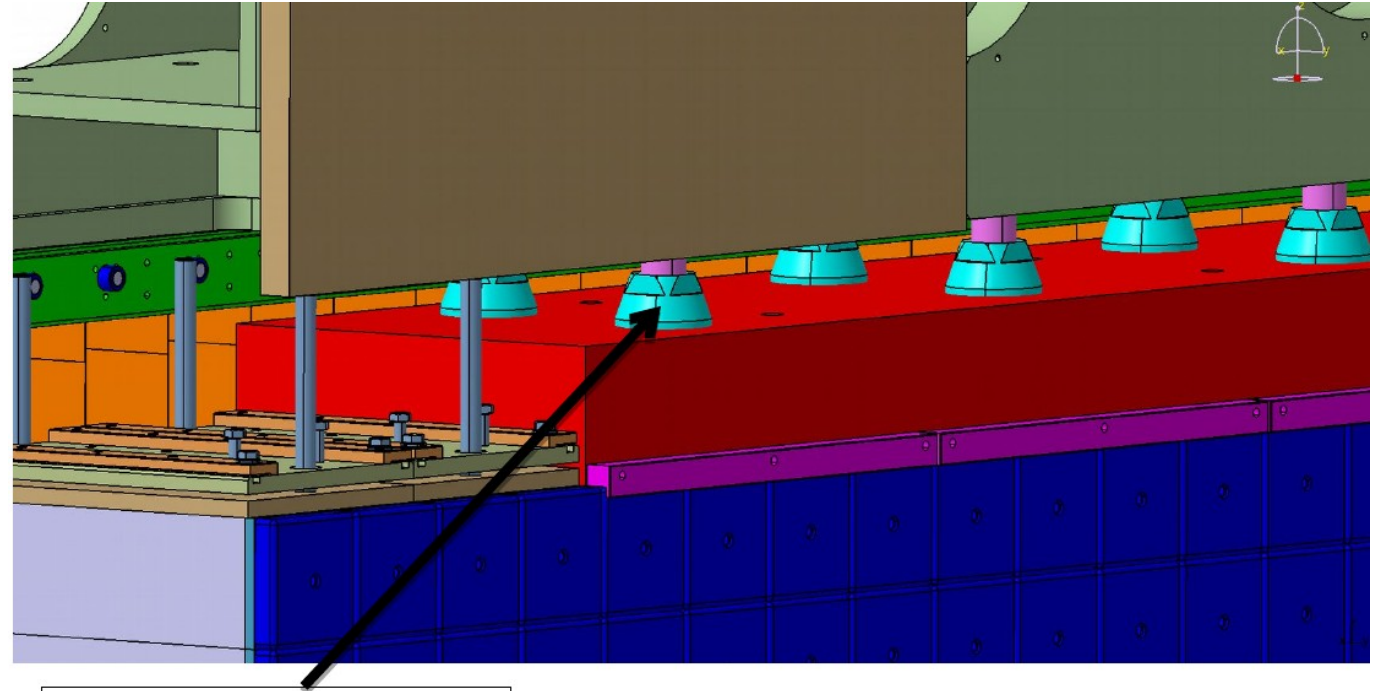
This permits a precise positioning of the row and a dense structure



# Mechanics

## Uniform load

applied at the top of the ECAL and maintained with mechanical jacks

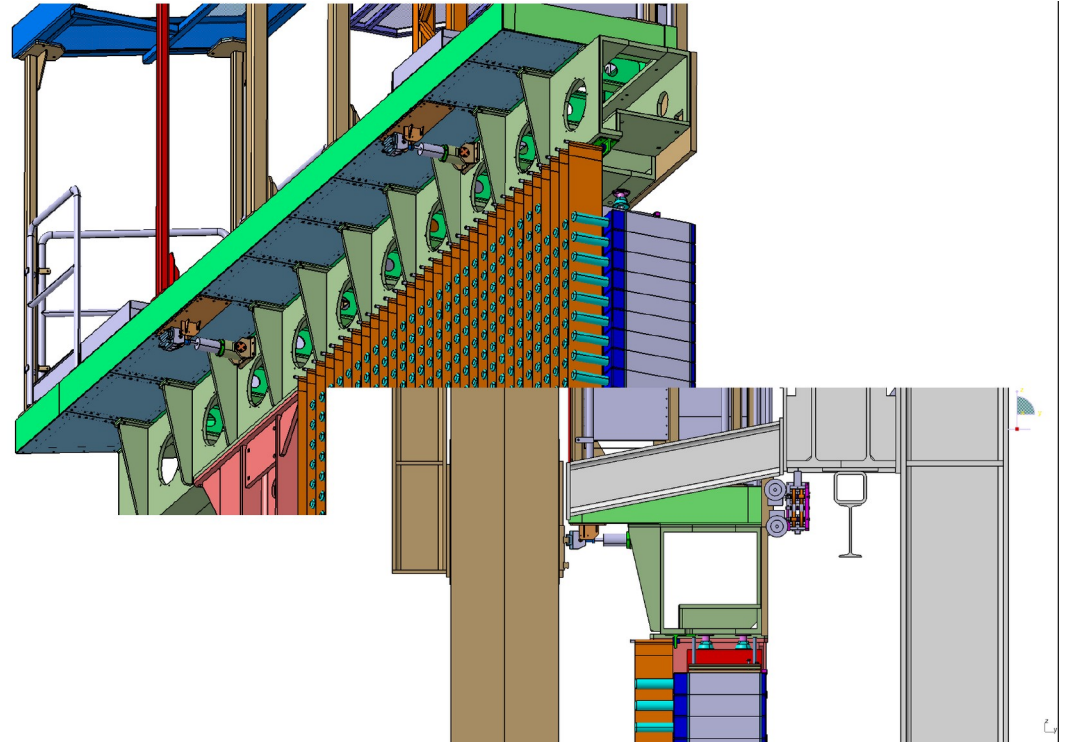


Mechanical jack

# Mechanics

## Seismic shock absorbers

located at the top of the ECAL structure, under the electronics platform



# Mechanics

## Cables, pipes, etc...

Signal cables

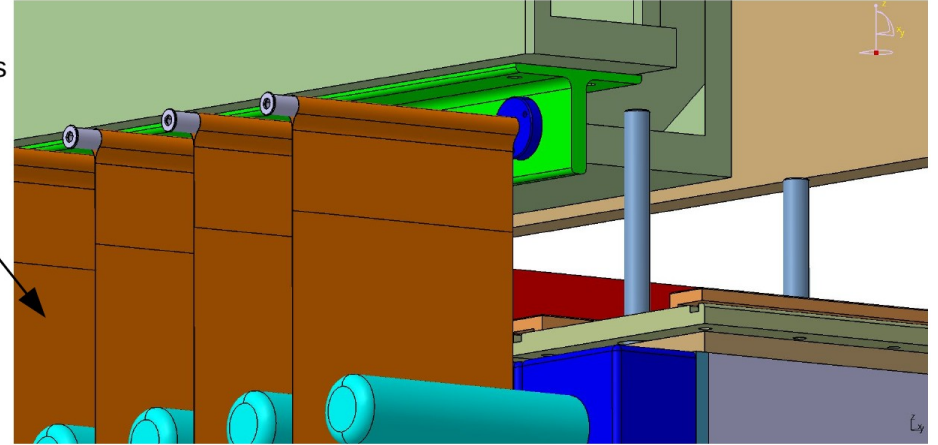
Power supplies (PMT, HV)

Calibration systems

LEDs

Cooling ?

steel cabling tapes



# Mechanics

## **Dismantling : tools and procedures**

### **Addressing the problem of modules with different depth**

Non uniform load

Can it be solved by adding some mechanical structure at the back of the shorter modules ? What is the impact of such an addition ?

Effect on the seismic constraints ?

Can we still pack the modules in groups of rows ?

### **Cables and electronic platform**

We may have to go from ~6000 channels to more than 32000... applying this factor on the electronics we go from 14 to 59 crates... can probably be handled by increasing the number of channels/FEB. However, the electronics location and space is an issue.

### **Assembly**

Tools have to be designed to assemble the detector (alignment, tools to carry the modules, etc...)

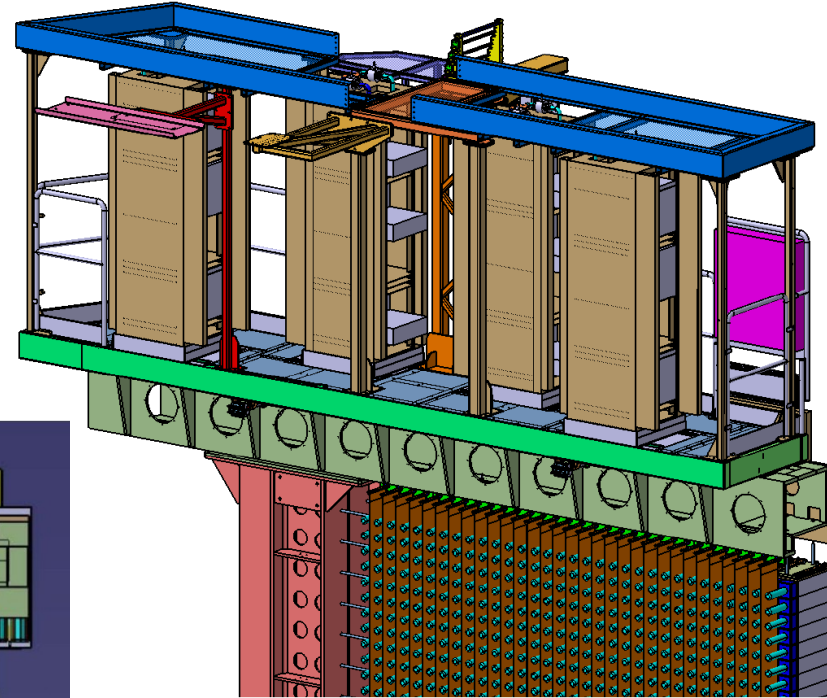
# Electronics

**The electronics is located on the calo platform, above the detector**

Cables length from PMT to FEB  $\sim$  15m

14 crates for the ECAL for  $\sim$ 250 FEB (32 channels/board)

6016 channels in the readout





# Electronics

## The FEB perform at 40MHz

Shaping and integration of the analog signal after 15m long cables

12 ADC conversion of the integrated signal

Signal treatment in MICROCHIP (ACTEL flash-based) FPGA

- Pedestal subtraction and low noise fluctuation removal

- Numerical corrections and event formatting

- Some trigger calculations which are sent to the PC farm (Upgrade I)

The trigger calculations are sums over 2x2 clusters ( $E_T$ ,  $E_T^{\text{Max}}$ , occupancy)

- Exchange of information at the borders of the regions treated by the FEBs

The data stream (Data+Trig) is sent on 4 optical links / FEB

# Electronics

## The plan is to

Introduce a time measurement with a precision in the range of 25-50ps

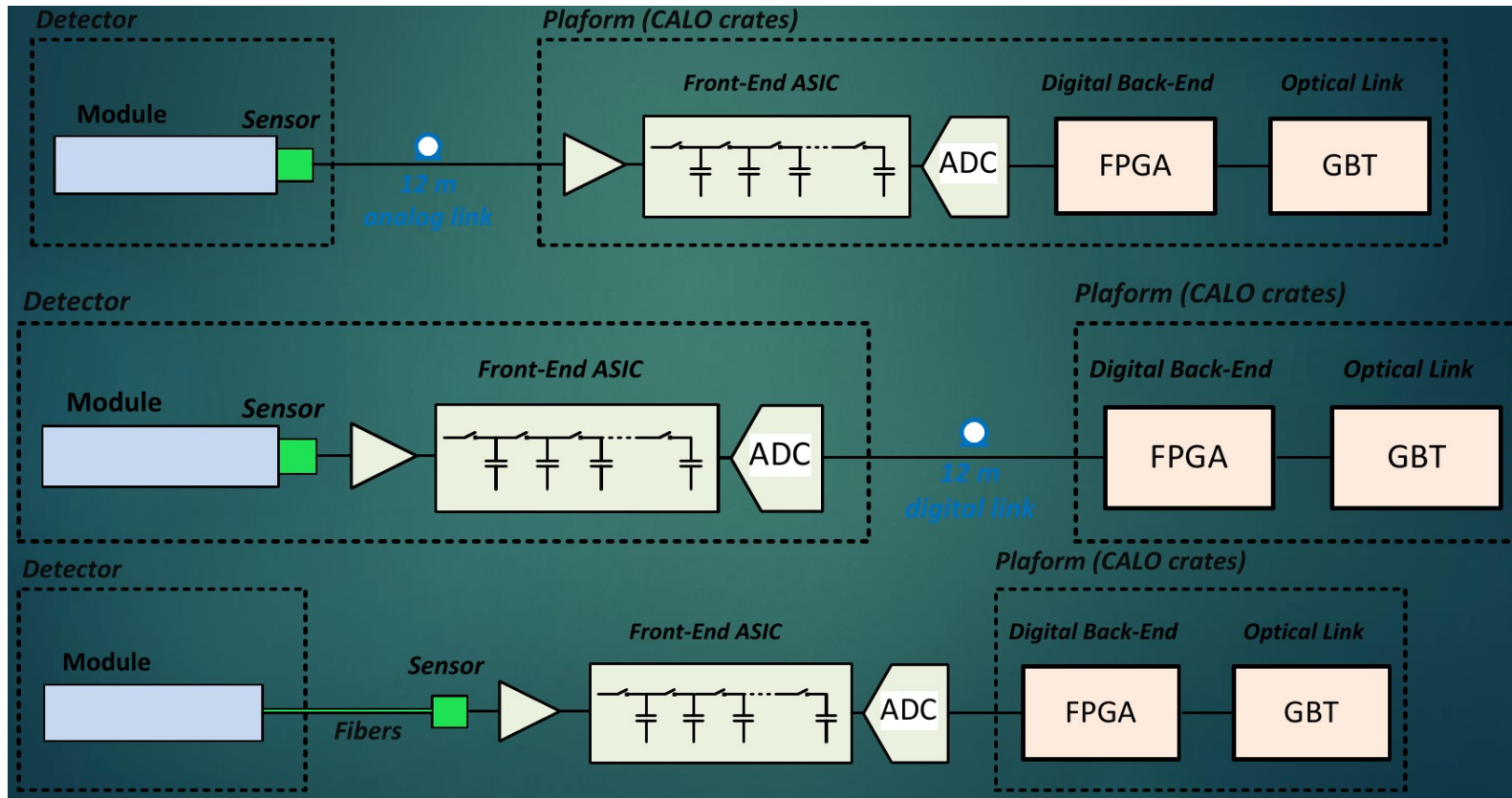
Increase the number of channels from 6k to >30k channels

The dynamic range should be at least 12 bits

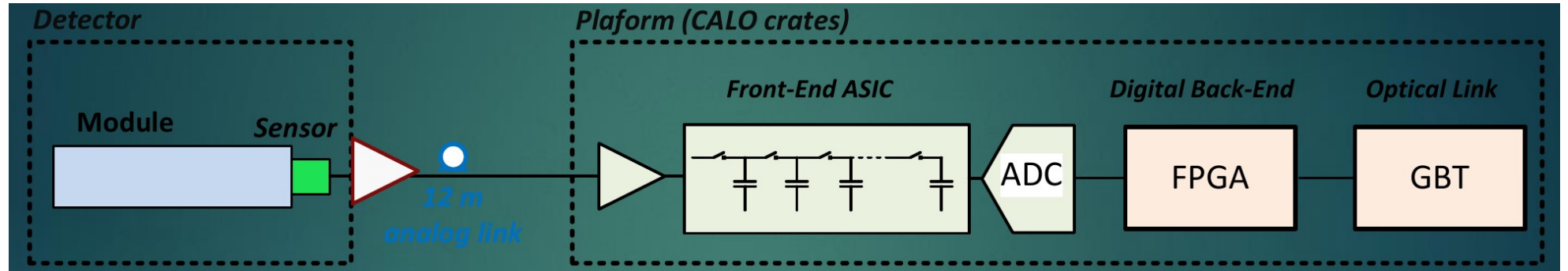
Include a double side readout

**In a drastically more difficult environment (radiations, 100Mrad)**

# Several architectures could be envisaged



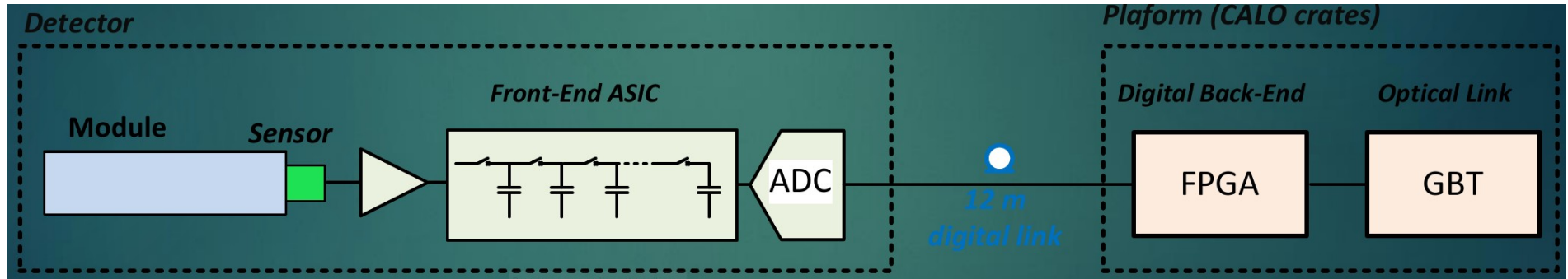
# Electronics



## One possibility may consist in

Sending the analog signal, potentially after amplification, to the FE on the platform  
A degradation of the time resolution could be expected beyond 15m

# Electronics



## But, a digital link could be used between a VFE and the platform

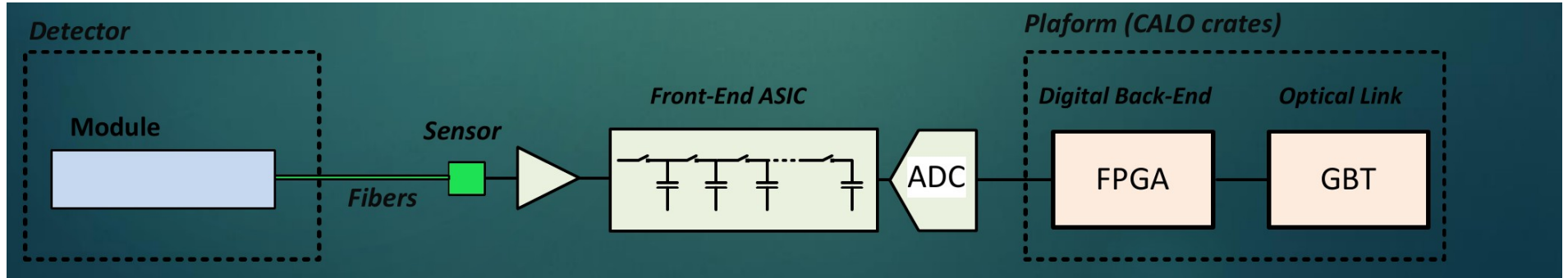
Challenging development as the ASIC would be in the high radiation region

The data bandwidth is also a challenging issue as each channel should be readout

Some treatments needed on the platform

Zero suppression, derandomization, sparsification, clusterisation, etc...

# Electronics



## Or optical links could transmit the signal to the sensors

Would remove the sensors from the hottest region

Light losses in the couplings could affect the time resolution

# Electronics

**A sampling of 500Ms/s should be sufficient for the time precision needed  
8 samples at 320MS/s would mean**

Energy → 12 bits, Time → 11 bits, Add → 5bits

32 channels x 40MHz x (Energy + Time) ~ 30Gbits/s

**Zero suppression and compression of the data are probably mandatory**

Adding a 10% occupancy and a header (Bxid, Add) ~6Gbits/s

**If we stick to 32 channels/FEB and use the SPD/PS crates which are available we may double the number of channels and reach 12000 channels**

But this is probably not good enough

Difficulty to handle many more channels on a single board (connectors)

# Electronics

These are just ideas of designs

Some working groups are being defined

<https://indico.cern.ch/event/960837/contributions/4044878/>

<https://indico.cern.ch/event/982989/>

<https://indico.cern.ch/event/960837/contributions/4044878/>



# Conclusions

## **Converging towards an upgraded calorimeter for LHCb**

### **A baseline proposal should be prepared soon (TDR)**

It is being defined now

However, many options, detectors and design are still on the table

This TDR is to give some ideas on the direction where would like to go to

New ideas and new contributions are welcome !

Spacal/Schashlik design, mechanics, light readout, time layer integration, long transmission line effect, analog signal processing, digital processing (FPGAs ? How to handle clusterisation, compression, zero suppression, etc... ?), board design, firmware development, crates, interconnections, power supplies, optical links, software and acquisition control, etc...